February 1997



#### **General Description**

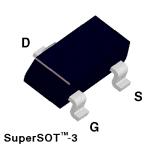
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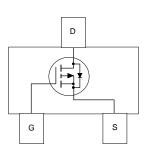
SEMICONDUCTOR TM

These P -Channel logic level enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications such as notebook computer power management, portable electronics, and other battery powered circuits where fast high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

#### Features

- $\begin{array}{c|c} \bullet & \text{-0.9 A, -30 V. } \mathsf{R}_{\mathsf{DS(ON)}} = 0.5 \; \Omega @ \mathsf{V}_\mathsf{GS} = \text{-4.5 V} \\ \mathsf{R}_{\mathsf{DS(ON)}} = 0.3 \; \Omega @ \mathsf{V}_\mathsf{GS} = \text{-10 V.} \end{array}$
- Industry standard outline SOT-23 surface mount package using proprietary SuperSOT<sup>™</sup>-3 design for superior thermal and electrical capabilities.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- Exceptional on-resistance and maximum DC current capability.





#### **Absolute Maximum Ratings** $T_{A} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		NDS352AP	Units
V <sub>DSS</sub>	Drain-Source Voltage		-30	V
V <sub>GSS</sub>	Gate-Source Voltage - Continuous		±20	V
I <sub>D</sub>	Maximum Drain Current - Continuous	(Note 1a)	±0.9	A
- Pulsed			±10	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	0.5	W
		(Note 1b)	0.46	
Г <sub>Ј</sub> ,Т <sub>STG</sub>	Operating and Storage Temperature Range	e	-55 to 150	°C
THERMA	L CHARACTERISTICS			
۲ <sub>өла</sub>	Thermal Resistance, Junction-to-Ambient (Note 1a)		250	
۲ <sub>өлс</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$		-30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$				-1	μA
			T <sub>J</sub> =125°C			-10	μA
GSSF	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	·			100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{\rm GS} = -20 \text{ V}, V_{\rm DS} = 0 \text{ V}$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$		-0.8	-1.7	-2.5	V
CO(al)			T <sub>J</sub> =125°C	-0.5	-1.4	-2.2	1
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -0.9 \text{ A}$			0.45	0.5	Ω
			T <sub>J</sub> =125°C		0.65	0.7	1
		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ A}$			0.25	0.3	]
D(ON)	On-State Drain Current	V <sub>GS</sub> = -4.5 V, V <sub>DS</sub> = -5 V		-2			Α
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5 V, I_{D} = -0.9 A$			1.9		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1.0 MHz			135		pF
C <sub>oss</sub>	Output Capacitance				88		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				40		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
d(on)	Turn - On Delay Time	$V_{DD} = -6 \text{ V}, \text{ I}_{D} = -1 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			5	10	ns
r	Turn - On Rise Time				17	30	ns
d(off)	Turn - Off Delay Time				35	70	ns
f	Turn - Off Fall Time				30	60	ns
d(on)	Turn - On Delay Time	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 50 \Omega$			8	15	ns
r	Turn - On Rise Time				16	30	ns
d(off)	Turn - Off Delay Time				35	90	ns
f	Turn - Off Fall Time				30	90	ns
J <sup>°</sup>	Total Gate Charge	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -0.9 \text{ A},$ $V_{GS} = -4.5 \text{ V}$			2	3	nC
ي ک <sup>ور</sup>	Gate-Source Charge				0.5		nC
2 <sub>gd</sub>	Gate-Drain Charge				1		nC

Electrical Characteristics (T <sub>A</sub> = 25°C unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Тур	Max	Units
DRAIN-SO	URCE DIODE CHARACTERISTICS AND M	AXIMUM RATINGS		•	•	
I <sub>s</sub>	Maximum Continuous Source Current				-0.42	А
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				-10	А
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -0.42 \text{ (Note 2)}$		-0.8	-1.2	V

Notes:

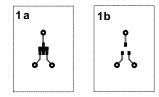
1. R<sub>Bub</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>Bub</sub> is guaranteed by design while R<sub>Bub</sub> is determined by the user's board design.

$$P_D(t) = \frac{T_J - T_A}{R_{\theta J A}(t)} = \frac{T_J - T_A}{R_{\theta J C} + R_{\theta C A}(t)} = I_D^2(t) \times R_{DS(ON) \otimes T_J}$$

Typical  $\rm R_{\rm 6JA}$  using the board layouts shown below on 4.5"x5" FR-4 PCB in a still air environment:

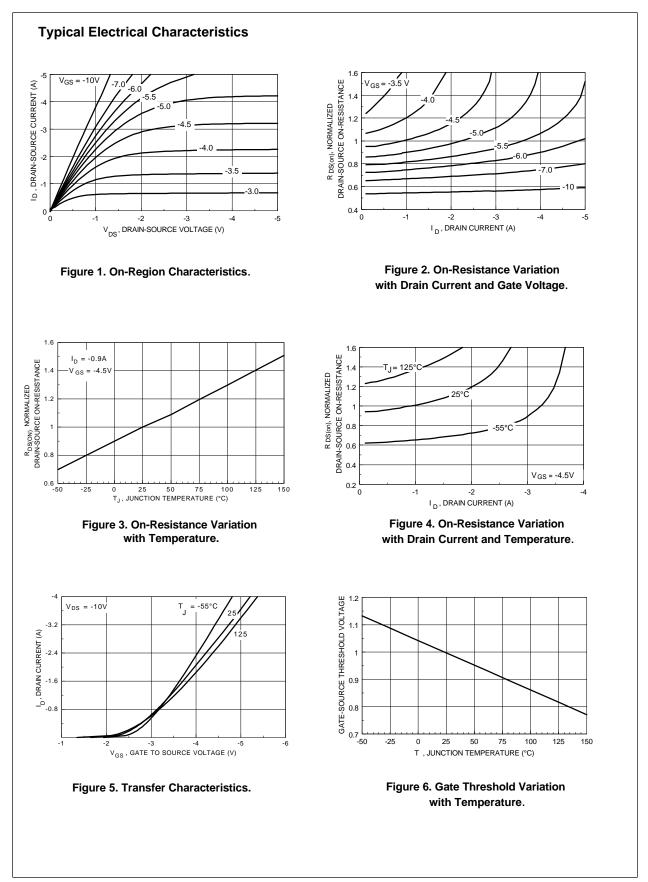
a. 250°C/W when mounted on a 0.02  $\mbox{in}^2$  pad of 2oz copper.



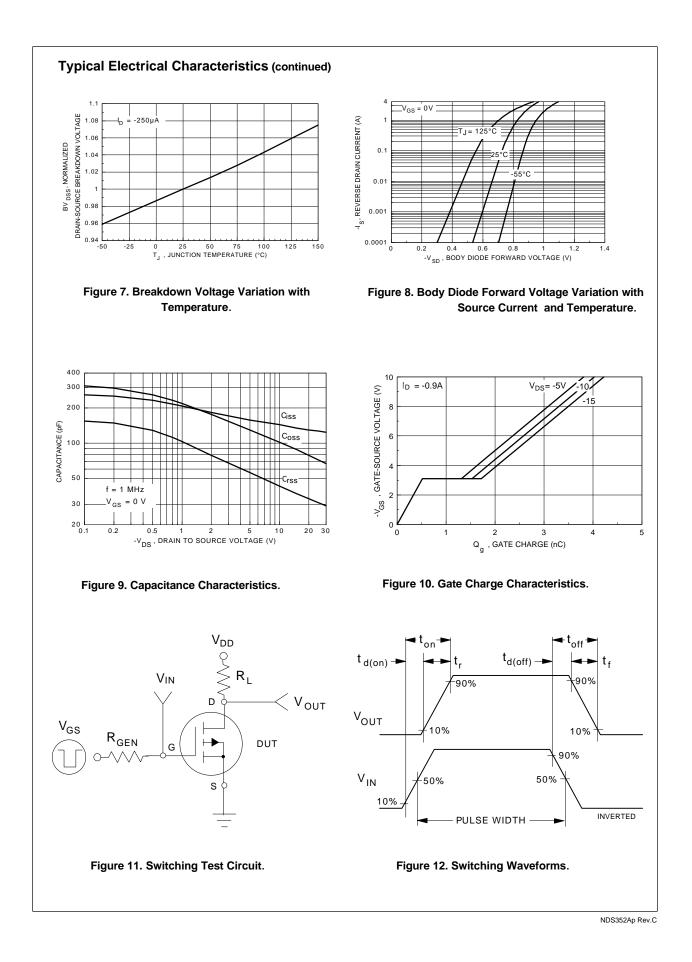


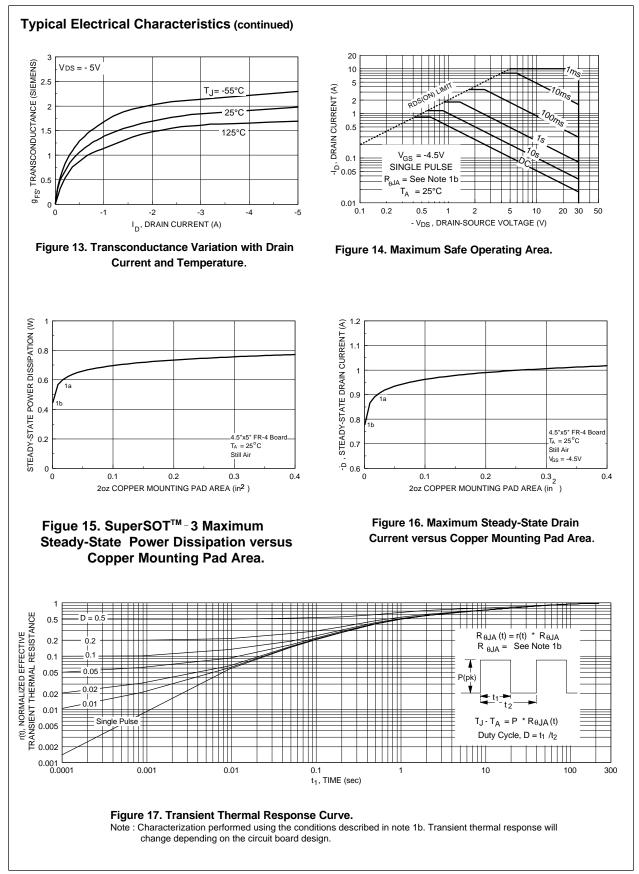
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%.



NDS352AP Rev.C





NDS352Ap Rev.C

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  - Direct +86 (21) 6401-6692
  - Email amall@ameya360.com
  - QQ 800077892
  - Skype ameyasales1 ameyasales2

## > Customer Service :

Email service@ameya360.com

# > Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com